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November 19, 2004

FN2914.6

150MHz, Fast Settling Operational Amplifier

The HA-5195 is a operational amplifier featuring a combination of speed, precision, and bandwidth. Employing monolithic bipolar construction coupled with Dielectric Isolation, this device is capable of delivering 200V/ μ s slew rate with a settling time of 70ns (0.1%, 5V output step). This truly differential amplifier is designed to operate at gains ≥ 5 without the need for external compensation. Other outstanding features are 150MHz gain bandwidth product and 6.5MHz full power bandwidth. In addition to these dynamic characteristics, this amplifier also has excellent input characteristics such as 3mV offset voltage and $6.0 \text{nV}/\sqrt{\text{Hz}}$ input voltage noise at 1kHz.

With 200V/ μ s slew rate and 70ns settling time, the HA-5195 is an ideal output amplifier for accurate, high speed D/A converters or the main components in high speed sample/hold circuits. The 5195 is also ideally suited for a variety of pulse and wideband video amplifiers. Please refer to Application Notes AN525 and AN526 for some of these application designs.

At temperatures above 75°C a heat sink is required for the HA-5195 (see Note 2 and Application Note AN556).

Part Number Information

PART NUMBER	TEMP. RANGE (°C)	PACKAGE	PKG. DWG.#
HA1-5195-5	0 to 75	14 Ld CERDIP	F14.3

Features

• Fast Settling Time (0.1%)	70ns
Very High Slew Rate	200V/μs
• Wide Gain-Bandwidth (A _V \geq 5)	150MHz
Full Power Bandwidth	6.5MHz
Low Offset Voltage	3mV
Input Noise Voltage	6nV/√Hz

Applications

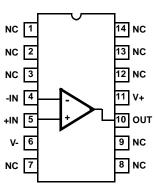
• Fast, Precise D/A Converters

· Bipolar D.I. Construction

- · High Speed Sample-Hold Circuits
- · Pulse and Video Amplifiers
- · Wideband Amplifiers

Pinout

HA-5195 (CERDIP) TOP VIEW



Thermal Information

Absolute Maximum Ratings $T_A = 25^{\circ}C$ Supply Voltage (V+ to V-)35VDifferential Input Voltage6VOutput Current50mA (Peak)

Operating Conditions

Temperature Range 0 °C to 75 °C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTES:

- 1. Heat sinking may be required, especially at $T_A \ge 75^{\circ}C$.
- 2. θ_{JA} is measured with the component mounted on an evaluation PC board in free air.

Electrical Specifications $V_{SUPPLY} = \pm 15V$, Unless Otherwise Specified

PARAMETER	TEST CONDITIONS	TEMP (°C)	MIN	TYP	MAX	UNITS
INPUT CHARACTERISTICS	·					
Offset Voltage		25	-	3	6	mV
		Full	-	-	10	mV
Average Offset Voltage Drift		Full	-	20	-	μV/ ^o C
Bias Current		25	-	5	15	μА
		Full	-	-	20	μА
Offset Current		25	-	1	4	μА
		Full	-	-	6	μА
Input Resistance		25	-	10	-	kΩ
Input Capacitance		25	-	1	-	pF
Common Mode Range		Full	±5	-	-	V
Input Noise Current	$f = 1kHz, R_G = 0\Omega$	25	-	5	-	pA/√Hz
Input Noise Voltage	$f = 1kHz, R_G = 0\Omega$	25	-	6	-	nV/√ Hz
TRANSFER CHARACTERISTICS		<u> </u>	l.			
Large Signal Voltage Gain (Note 3)		25	10	30	-	kV/V
		Full	5	-	-	kV/V
Common Mode Rejection Ratio	$\Delta V_{CM} = \pm 5V$	Full	74	95	-	dB
Minimum Stable Gain		25	5	-	-	V/V
Gain-Bandwidth-Product	$V_{OUT} = 90 \text{mV}, A_{V} = 10$	25	150	-	-	MHz
OUTPUT CHARACTERISTICS		<u> </u>	l.			
Output Voltage Swing (Note 3)		Full	±5	±8	-	V
Output Current (Note 3)		25	±25	±30	-	mA
Output Resistance	Open Loop	25	-	30	-	Ω
Full Power Bandwidth (Notes 3, 4)		25	5	6.5	-	MHz
TRANSIENT RESPONSE (Note 5)		<u> </u>	l.			
Rise Time		25	-	13	18	ns
Overshoot		25	-	8	-	%
Slew Rate		25	160	200	-	V/μs
Settling Time (Note 5)	5V Step to 0.1%	25	70	-	-	ns
	5V Step to 0.01%	25	-	100	-	ns
	2.5V Step to 0.1%	25	-	50	-	ns
	2.5V Step to 0.01%	25	-	80	-	ns
POWER SUPPLY CHARACTERISTICS			•		•	•
Supply Current		Full	-	19	28	mA

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Electrical Specifications $V_{SUPPLY} = \pm 15V$, Unless Otherwise Specified (Continued)

PARAMETER	TEST CONDITIONS	TEMP (°C)	MIN	TYP	MAX	UNITS
Power Supply Rejection Ratio	$\Delta V_S = \pm 10 V$ to $\pm 20 V$	Full	70	90	-	dB

NOTES:

- 3. $R_L = 200\Omega$, $C_L < 10pF$, $V_{OUT} = \pm 5V$.
- 4. Full power bandwidth guaranteed based on slew rate measurement using: FPBW = $\frac{\text{Slew Rate}}{2\pi \text{V}_{\text{PEAK}}}$
- 5. Refer to Test Circuits section of the data sheet.

Test Circuits and Waveforms

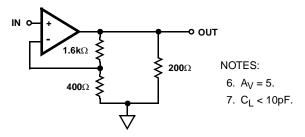
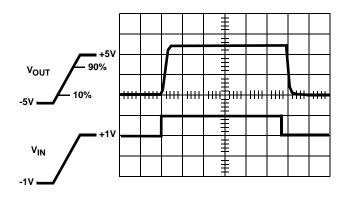
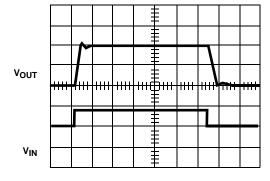


FIGURE 1. LARGE AND SMALL SIGNAL RESPONSE TEST CIRCUIT

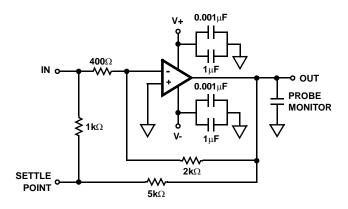


Vertical Scale: $V_{IN} = 2.0V/Div.$, $V_{OUT} = 4.0/Div.$ Horizontal Scale: 100ns/Div.



 $\label{eq:Volume} \mbox{Vertical Scale: } \mbox{$V_{IN} = 50 mV/Div.}, \mbox{$V_{OUT} = 100 mV/Div.}$ Horizontal Scale: 100ns/Div **SMALL SIGNAL RESPONSE**

LARGE SIGNAL RESPONSE



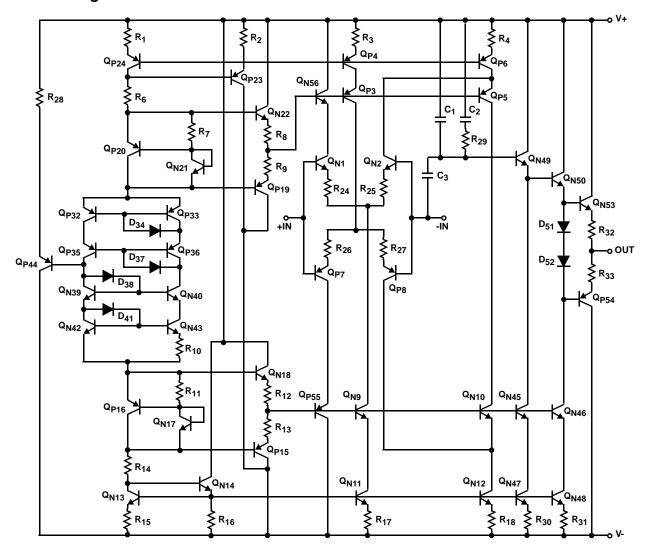
8. $A_V = -5$.

NOTES:

- 9. Load Capacitance should be less than 10pF.
- 10. It is recommended that resistors be carbon composition and that feedback and summing network ratios be matched to 0.1%.
- 11. Settle Point (Summing Node) capacitance should be less than 10pF. For optimum settling time results, it is recommended that the test circuit be constructed directly onto the device pins. A Tektronix 568 Sampling Oscilloscope with S-3A sampling heads is recommended as a settle point monitor.

FIGURE 2. SETTLING TIME TEST CIRCUIT

Schematic Diagram



Application Information

Power Supply Decoupling

Although not absolutely necessary, it is recommended that all power supply lines be decoupled with $0.01\mu F$ ceramic capacitors to ground. Decoupling capacitors should be located as near to the amplifier terminals as possible.

Stability Considerations

HA-5195 is stable at gains > 5. Gains < 5 are covered below. Feedback resistors should be of carbon composition located as near to the input terminals as possible.

Wiring Considerations

Video pulse circuits should be built on a ground plane. Minimum point to point connections directly to the amplifier terminals should be used. When ground planes cannot be used, good single point grounding techniques should be applied.

Output Short Circuit

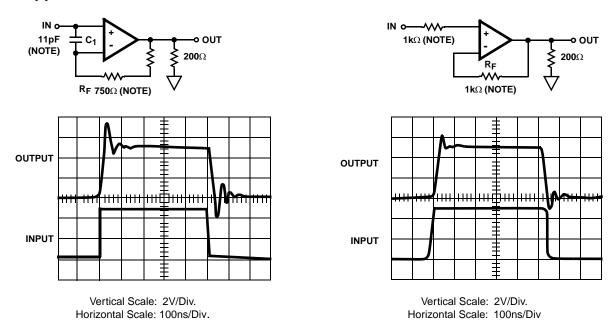
HA-5195 does not have output short circuit protection. Short circuits to ground can be tolerated for approximately 10 seconds. Short circuits to either supply will result in immediate destruction of the device.

Heavy Capacitive Loads

When driving heavy capacitive loads (>100pF) a small resistor (100 Ω) should be connected in series with the output and inside the feedback loop.

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Typical Applications (Also see Application Notes AN525 and AN526)



NOTE: Values were determined experimentally for optimum speed and settling time. R_F and C₁ should be optimized for each particular application to ensure best overall frequency response.

FIGURE 3. SUGGESTED COMPENSATION FOR NONINVERTING UNITY GAIN AMPLIFIER

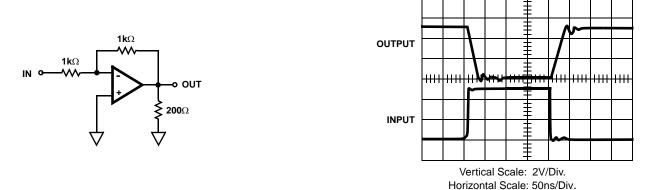


FIGURE 4. SUGGESTED COMPENSATION FOR INVERTING UNITY GAIN AMPLIFIER

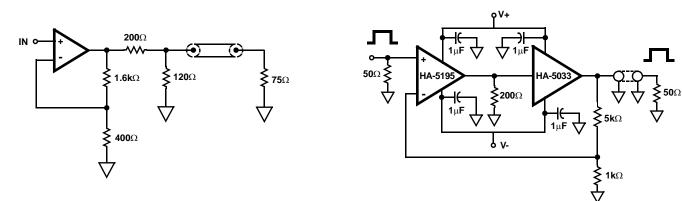


FIGURE 5. VIDEO PULSE AMPLIFIER/75 Ω COAXIAL DRIVER

FIGURE 6. VIDEO PULSE AMPLIFIER COAXIAL LINE DRIVER

Typical Performance Curves $V_S = \pm 15V$, $T_A = 25^{\circ}C$, Unless Otherwise Specified

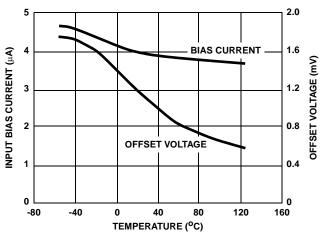


FIGURE 7. INPUT OFFSET VOLTAGE AND BIAS CURRENT vs TEMPERATURE

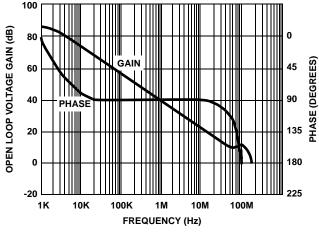


FIGURE 8. OPEN LOOP FREQUENCY RESPONSE

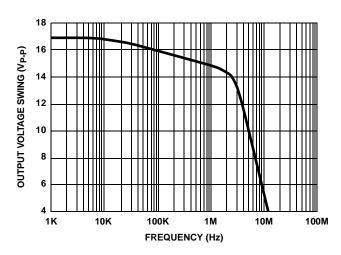


FIGURE 9. OUTPUT VOLTAGE SWING vs FREQUENCY

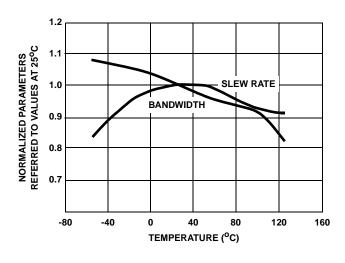


FIGURE 10. NORMALIZED AC PARAMETERS vs TEMPERATURE

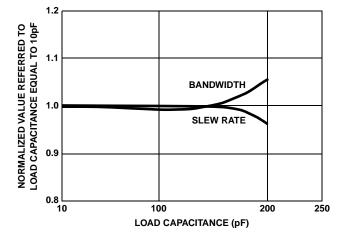


FIGURE 11. NORMALIZED AC PARAMETERS vs LOAD CAPACITANCE

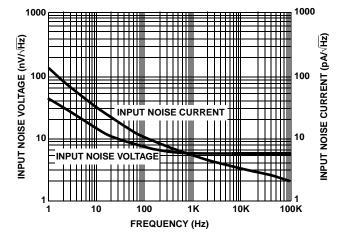


FIGURE 12. INPUT NOISE VOLTAGE AND NOISE CURRENT vs FREQUENCY

Typical Performance Curves $V_S = \pm 15V$, $T_A = 25^{\circ}C$, Unless Otherwise Specified (Continued)

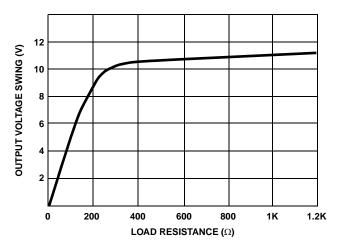


FIGURE 13. OUTPUT VOLTAGE SWING vs LOAD RESISTANCE

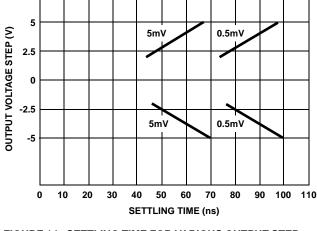


FIGURE 14. SETTLING TIME FOR VARIOUS OUTPUT STEP VOLTAGES

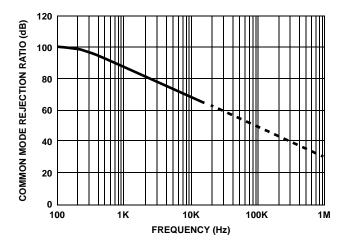


FIGURE 15. COMMON MODE REJECTION RATIO vs FREQUENCY

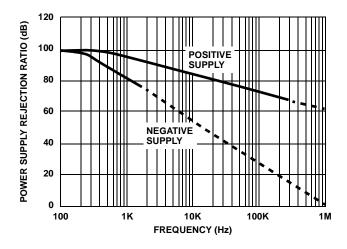


FIGURE 16. POWER SUPPLY REJECTION RATIO vs FREQUENCY

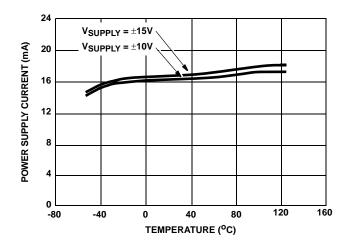


FIGURE 17. POWER SUPPLY CURRENT vs TEMPERATURE

Die Characteristics

DIE DIMENSIONS:

54 mils x 88 mils x 19 mils 1360μm x 2240μm x 483μm

METALLIZATION:

Type: AI, 1% Cu Thickness: 16kÅ ±2kÅ

PASSIVATION:

Type: Nitride (Si $_3$ N $_4$) over Silox (SiO $_2$, 5% Phos.) Silox Thickness: 12kÅ \pm 2kÅ

Silox Thickness: 12kA ±2kA Nitride Thickness: 3.5kÅ ±1.5kÅ

Metallization Mask Layout

SUBSTRATE POTENTIAL (Powered Up):

V-

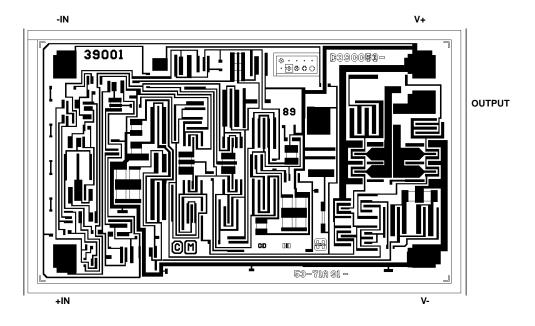
TRANSISTOR COUNT:

49

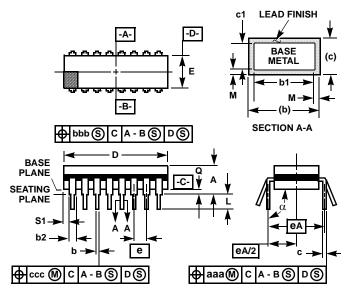
PROCESS:

Bipolar Dielectric Isolation

HA-5195



Ceramic Dual-In-Line Frit Seal Packages (CERDIP)



NOTES:

- Index area: A notch or a pin one identification mark shall be located adjacent to pin one and shall be located within the shaded area shown. The manufacturer's identification shall not be used as a pin one identification mark.
- The maximum limits of lead dimensions b and c or M shall be measured at the centroid of the finished lead surfaces, when solder dip or tin plate lead finish is applied.
- Dimensions b1 and c1 apply to lead base metal only. Dimension M applies to lead plating and finish thickness.
- Corner leads (1, N, N/2, and N/2+1) may be configured with a partial lead paddle. For this configuration dimension b3 replaces dimension b2.
- 5. This dimension allows for off-center lid, meniscus, and glass overrun.
- 6. Dimension Q shall be measured from the seating plane to the base plane.

9

- 7. Measure dimension S1 at all four corners.
- 8. N is the maximum number of terminal positions.
- 9. Dimensioning and tolerancing per ANSI Y14.5M 1982.
- 10. Controlling dimension: INCH.

F14.3 MIL-STD-1835 GDIP1-T14 (D-1, CONFIGURATION A)
14 LEAD CERAMIC DUAL-IN-LINE FRIT SEAL PACKAGE

	INCHES		MILLIM				
SYMBOL	MIN	MAX	MIN	MAX	NOTES		
Α	-	0.200	-	5.08	-		
b	0.014	0.026	0.36	0.66	2		
b1	0.014	0.023	0.36	0.58	3		
b2	0.045	0.065	1.14	1.65	-		
b3	0.023	0.045	0.58	1.14	4		
С	0.008	0.018	0.20	0.46	2		
c1	0.008	0.015	0.20	0.38	3		
D	-	0.785	-	19.94	5		
E	0.220	0.310	5.59	7.87	5		
е	0.100 BSC		2.54 BSC		2.54 BSC		-
eA	0.300	BSC	7.62 BSC		-		
eA/2	0.150	0.150 BSC		3.81 BSC			
L	0.125	0.200	3.18	5.08	-		
Q	0.015	0.060	0.38	1.52	6		
S1	0.005	-	0.13	-	7		
α	90°	105 ⁰	90°	105 ⁰	-		
aaa	-	0.015	-	0.38	-		
bbb	-	0.030	-	0.76	-		
ссс	-	0.010	-	0.25	-		
М	-	0.0015	-	0.038	2, 3		
N	1	14		14			

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